



PATENT  
0152-0551P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Hideyuki ARIYASU et al Conf.: 7701  
Appl. No.: 09/773,627 Group: 1773  
Filed: February 2, 2001 Examiner: KRUER  
For: THERMOPLASTIC RESIN INTEGRATED  
STRUCTURE

RECEIVED  
DEC 10 2003  
TC 1700

**REQUEST FOR RECONSIDERATION**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

December 8, 2003

Sir:

In reply to the Office Action dated September 8, 2003, the following Remarks are respectfully submitted in connection with the above-identified application.